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OVERVIEW

Timeline

- Project start date: FY 10/1/2018
- Project end date: FY 9/30/2024
- Percent completed: 90%

Budget

- Total project funding: \$ 1,900,000
 - DOE share: \$ 1,900,000
- Funding for FY 2023: \$ 250,000
- Funding for FY 2024: \$ 250,000

Barriers

- Size and weight, cost, performance and lifetime

RELEVANCE

- Thermal management is essential to increase power density and reliability.

Project Objectives

- Develop thermal management techniques to enable achieving the (year 2025) DOE 100-kW/L power density target.
- Enable high-temperature (250°C) and high-heat-flux wide-bandgap power electronics.

SUMMARY

Approach

- Develop single-phase heat transfer, dielectric fluid cooling strategies to decrease junction-to-fluid thermal resistance and enable increased power density.

Technical Accomplishments

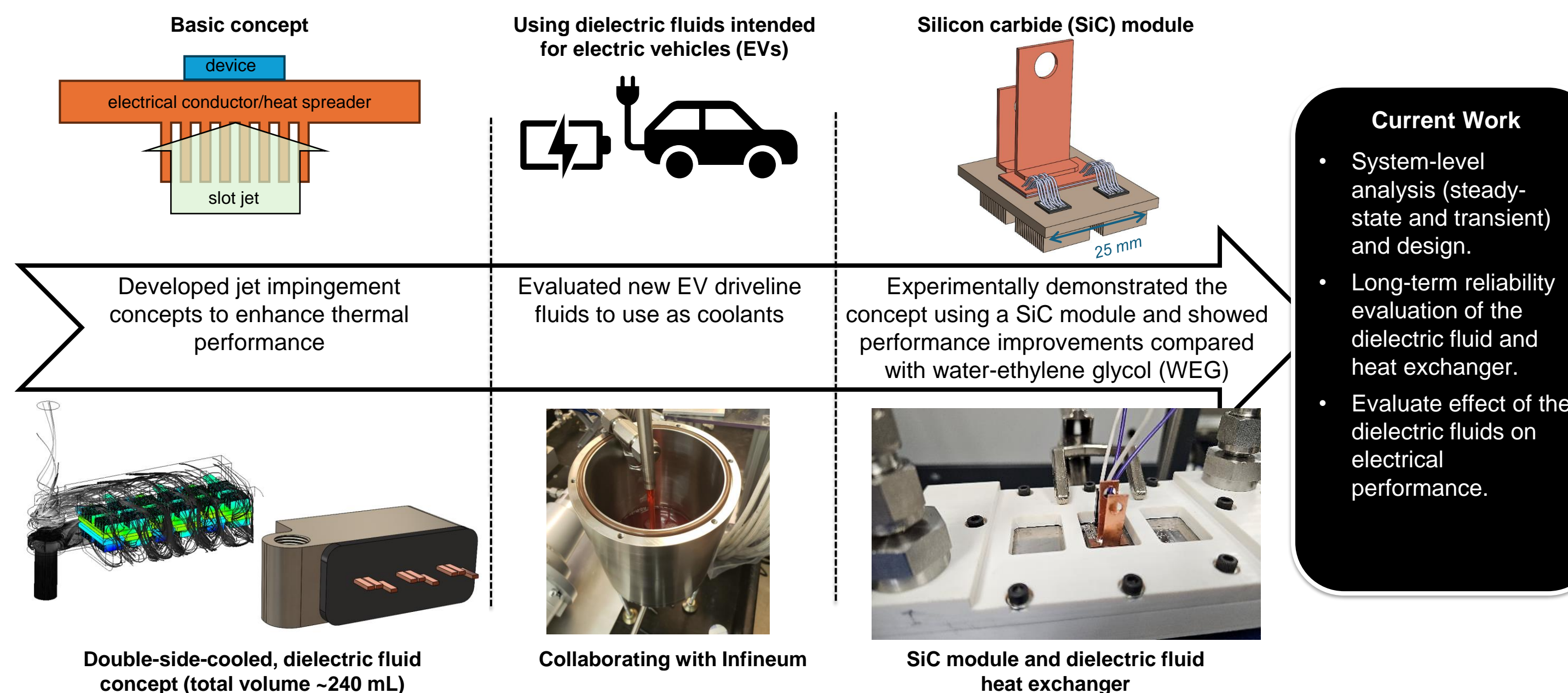
- Evaluated the transient performance of the dielectric fluid concept using drive cycle profiles.
- Sized an air-cooled heat exchanger for the dielectric fluid concept and compared its size to that of a WEG-to-air heat exchanger.
- Initiated long-term reliability experimental evaluation of the dielectric fluid and heat exchanger.
- Developed electrical models to evaluate the effect of the dielectric fluid on electrical performance.

APPROACH

Motivation

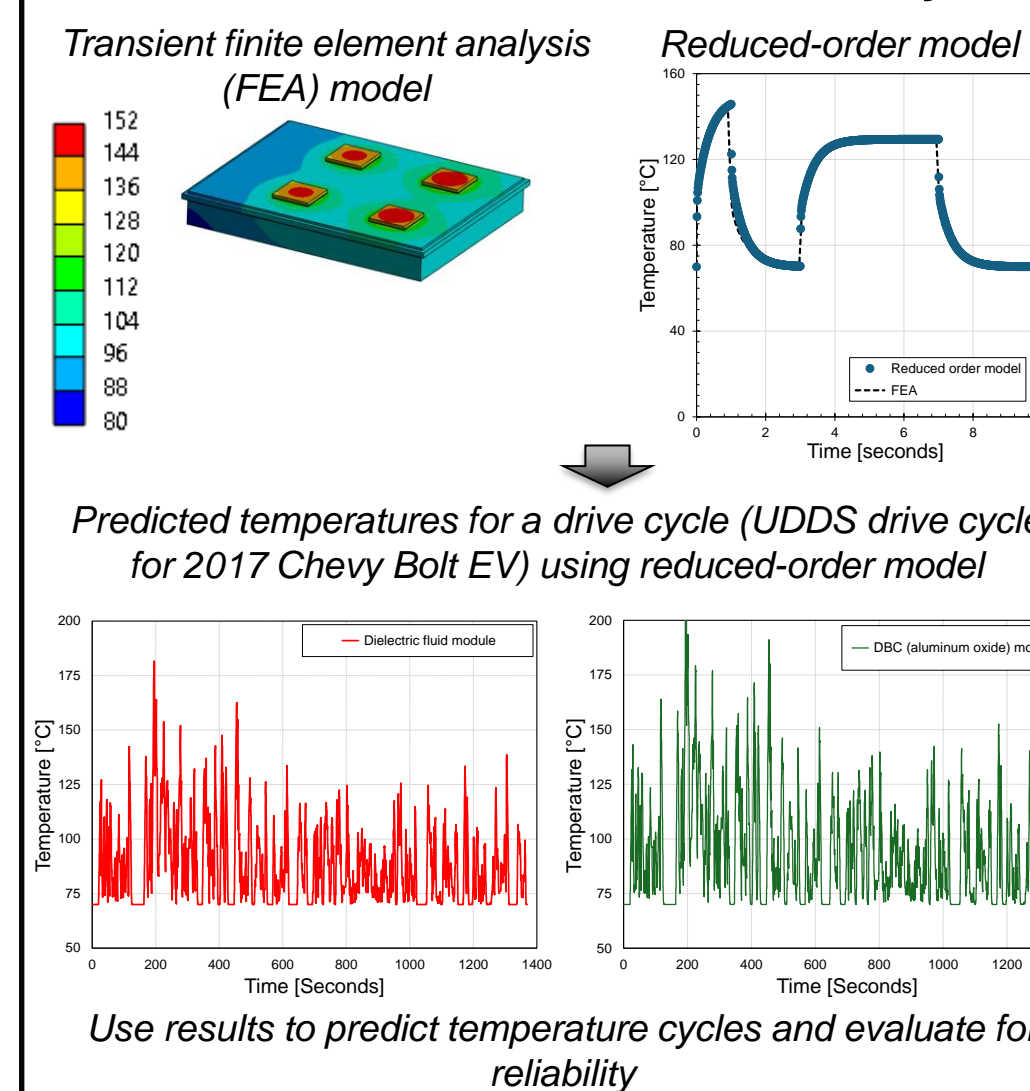
Package conduction resistance is the dominant resistance for existing power modules. Dielectric fluids enable a redesign of the package to minimize package resistance (i.e., eliminate the ceramic), allow for bus bar cooling, eliminate expensive ceramic substrates, and enable use of new automatic transmission fluid (ATF)-like fluids for direct cooling of power electronics modules.

Dielectric Fluid Cooling (Single Phase) of Power Electronics

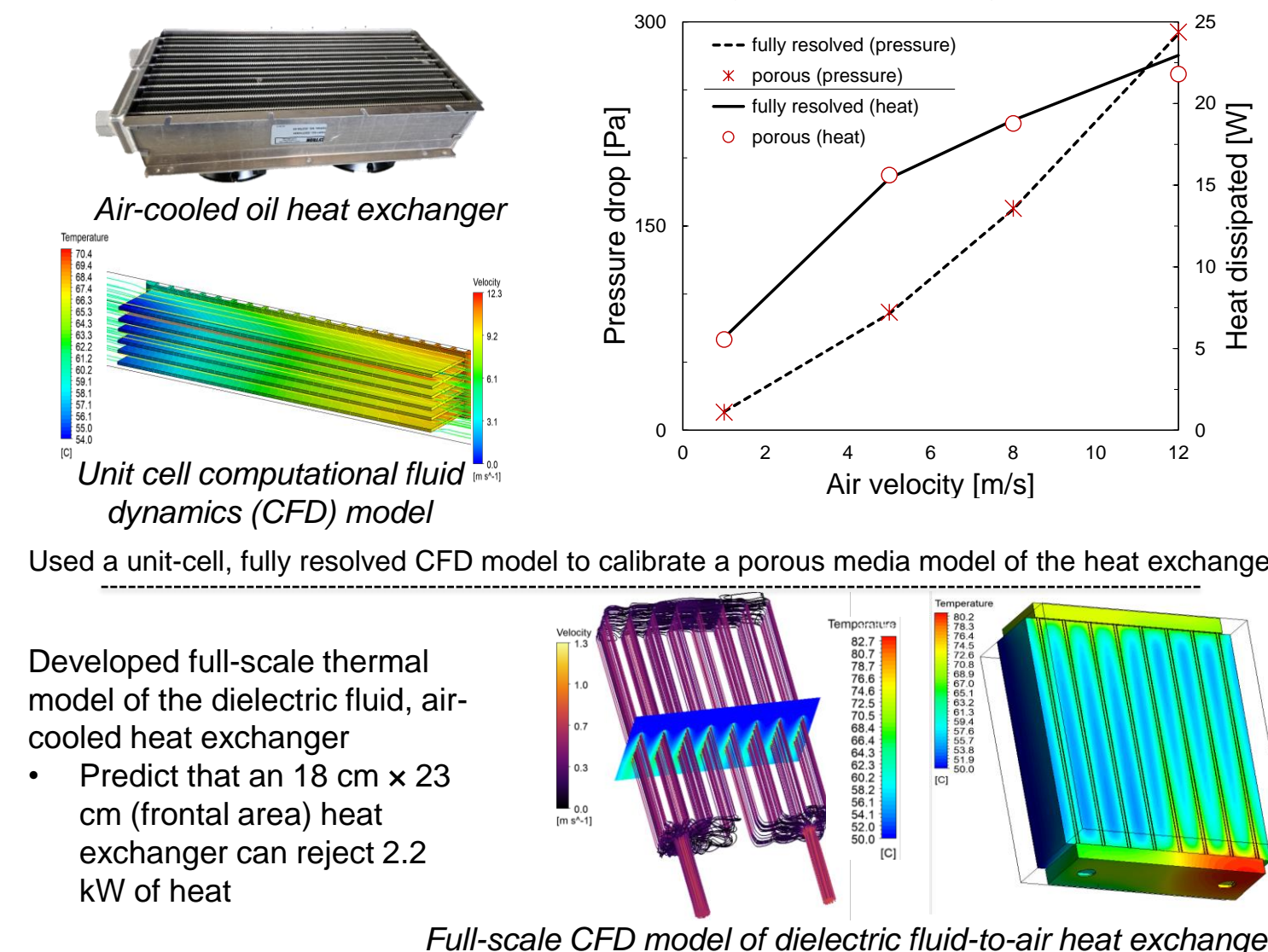


TECHNICAL ACCOMPLISHMENTS AND PROGRESS

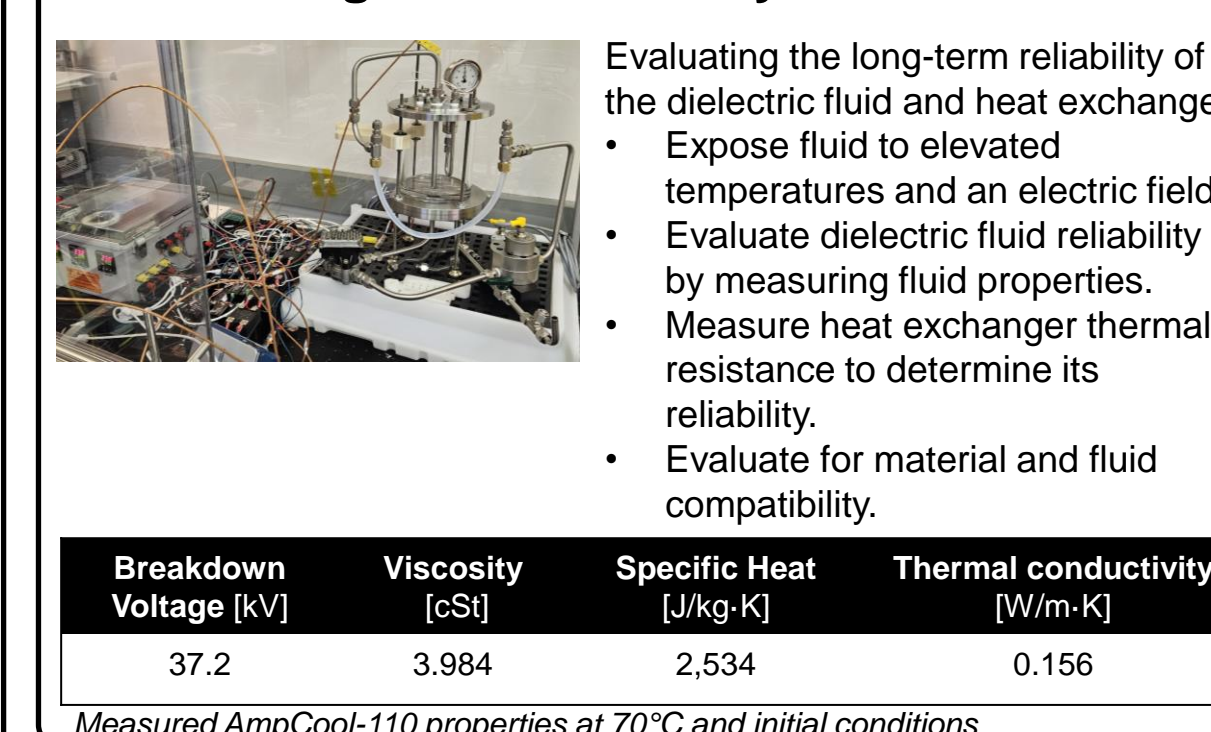
Dielectric Module Transient Analysis



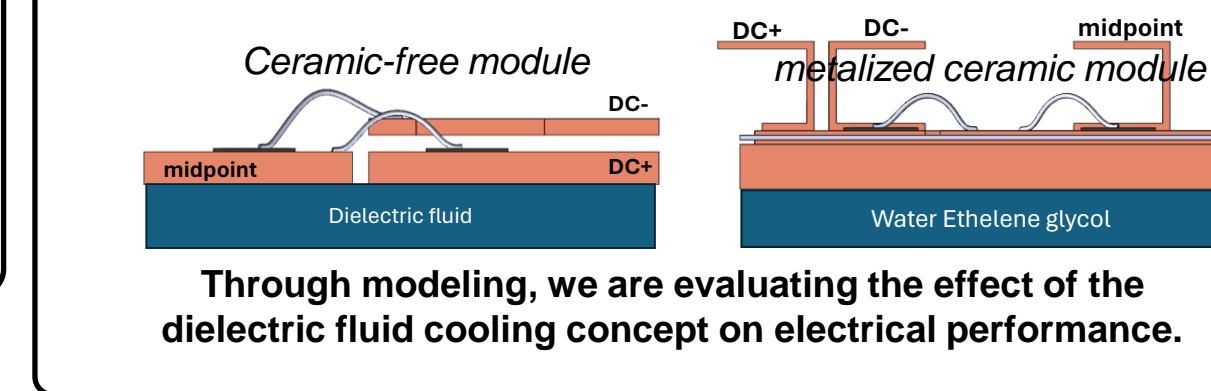
Dielectric Fluid Heat Rejection Analysis



Long-Term Reliability Evaluation



Electrical Performance Evaluation



System-level, transient thermal model to evaluate various operating conditions (e.g., drive cycles)

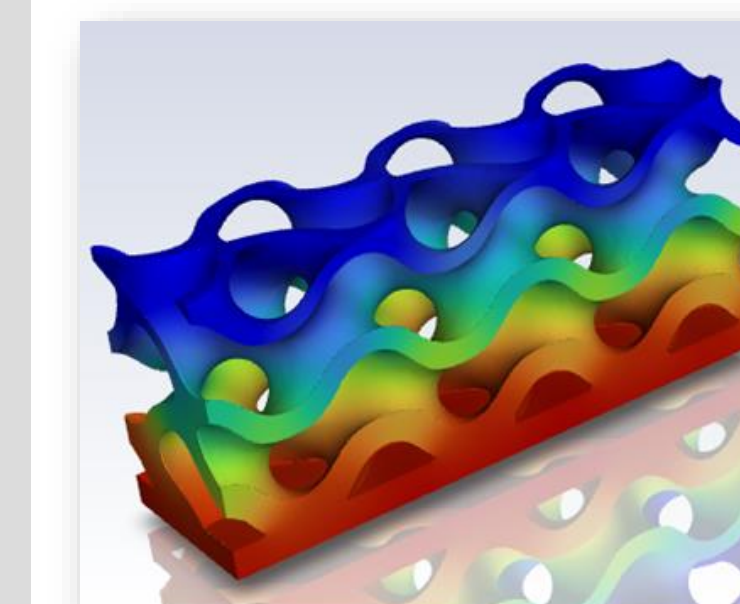
FUTURE WORK/CHALLENGES AND BARRIERS

- Complete electrical simulations to evaluate the effect of the dielectric fluid concept on electrical performance.
- Complete the dielectric fluid reliability evaluation.
- Complete the system-level modeling work.
- Collaborate with Georgia Tech to evaluate and develop the advanced cooling technologies.

Any proposed future work is subject to change based on funding levels.

COLLABORATIONS

- Collaborating with Georgia Tech (Professor Y. Joshi and Ubade Kemerli) to evaluate the use of gyroid (triple period minimal surface [TPMS]) structures as surface enhancement structures for dielectric fluid heat exchangers.



Gyroid structures were evaluated under various dielectric fluid flow configurations. Initial results predict improved thermal performance compared with existing, linear fin design.

- Collaborating with Infineum (Ryan Rieth, Sonia Oberoi, and Scott Campbell) to evaluate new driveline fluids being developed for EV, direct cooling applications.
- Collaborating with SUNY Poly (Woongje Sung) to use their SiC devices in our demonstration modules.
- Collaborating with Oak Ridge National Laboratory to understand the effects of dielectric fluids cooling strategy on device electrical performance.

ACKNOWLEDGMENTS

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